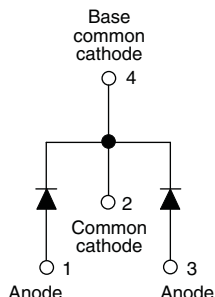


# Ultrafast Rectifier, 2 x 3 A FRED Pt®



TO-252AA (D-PAK)



## FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## PRODUCT SUMMARY

Package	TO-252AA (D-PAK)
$I_{F(AV)}$	2 x 3 A
$V_R$	200 V
$V_F$ at $I_F$	0.9 V
$t_{rr}$ typ.	See Recovery table
$T_J$ max.	175 °C
Diode variation	Common cathode

## DESCRIPTION / APPLICATIONS

Vishay Semiconductors' 200 V series are the state of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Peak repetitive reverse voltage	$V_{RRM}$		200	V
Average rectified forward current per device	$I_{F(AV)}$	Total device, rated $V_R$ , $T_C = 159\text{ °C}$	6	A
Non-repetitive peak surge current	$I_{FSM}$		50	
Peak repetitive forward current per diode	$I_{FM}$	Rated $V_R$ , square wave, 20 kHz, $T_C = 159\text{ °C}$	6	
Operating junction and storage temperatures	$T_J, T_{Stg}$		-65 to +175	°C

## ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100\text{ }\mu\text{A}$	200	-	-	V
Forward voltage	$V_F$	$I_F = 3\text{ A}$	-	-	1	
		$I_F = 3\text{ A}, T_J = 125\text{ °C}$	-	-	0.9	
		$I_F = 6\text{ A}$	-	-	1.2	
		$I_F = 6\text{ A}, T_J = 125\text{ °C}$	-	-	1.08	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	-	5	$\mu\text{A}$
		$T_J = 125\text{ °C}, V_R = V_R$ rated	-	-	100	
Junction capacitance	$C_T$	$V_R = 200\text{ V}$	-	12	-	pF
Series inductance	$L_S$	Measured lead to lead 5 mm from package body	-	8.0	-	nH

**DYNAMIC RECOVERY CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1.0\text{ A}$ , $dI_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	20	35	ns
		$T_J = 25\text{ }^{\circ}\text{C}$	-	19	-	
		$T_J = 125\text{ }^{\circ}\text{C}$	-	26	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	3.1	-	A
		$T_J = 125\text{ }^{\circ}\text{C}$	-	4.6	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^{\circ}\text{C}$	-	30	-	nC
		$T_J = 125\text{ }^{\circ}\text{C}$	-	60	-	

**THERMAL - MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J$ , $T_{Stg}$	-65	-	175	$^{\circ}\text{C}$
Thermal resistance, junction to case per leg	$R_{thJC}$	-	-	5	$^{\circ}\text{C}/\text{W}$
Thermal resistance, junction to ambient per leg	$R_{thJA}$	-	-	80	
Thermal resistance, case to heatsink	$R_{thCS}$	-	-	-	
Weight		-	0.3	-	g
		-	0.01	-	oz.
Mounting torque		6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-252AA (D-PAK)		6CWH02FNH	

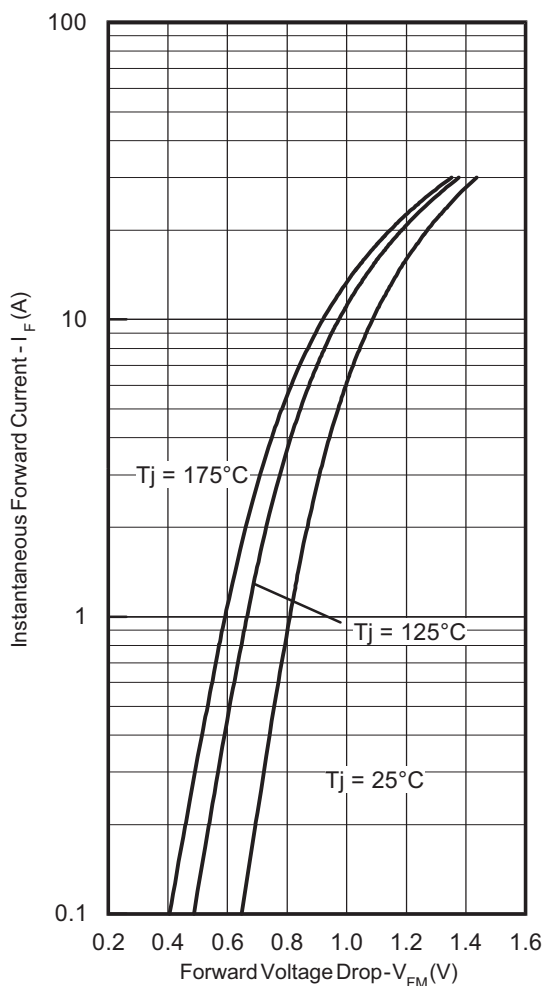


Fig. 1 - Maximum Forward Voltage Drop Characteristics

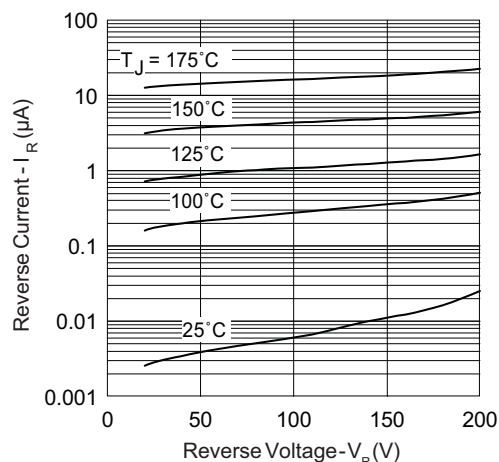


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

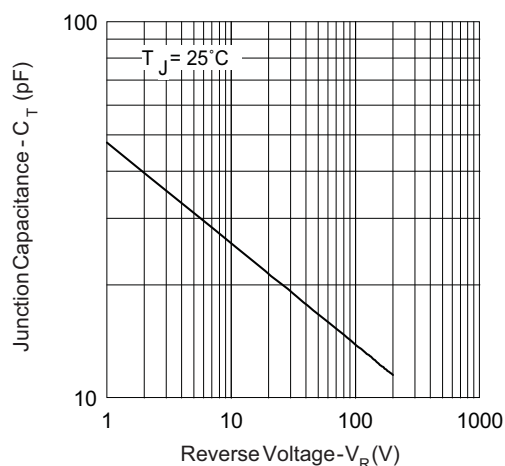
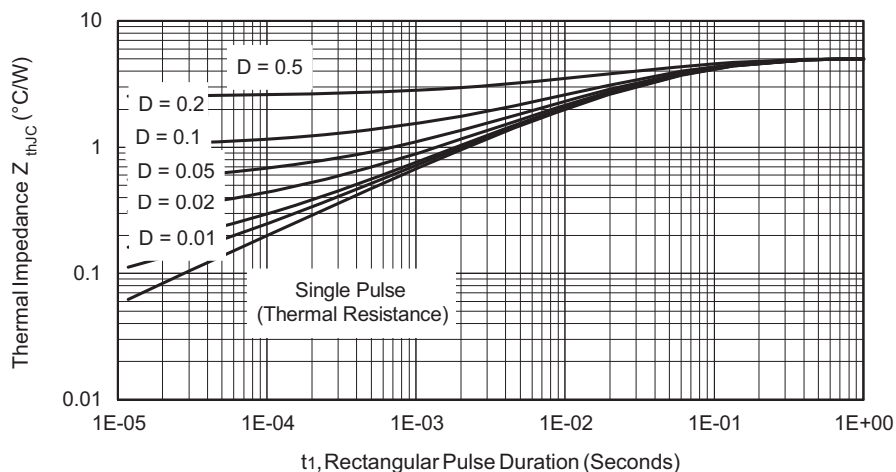


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

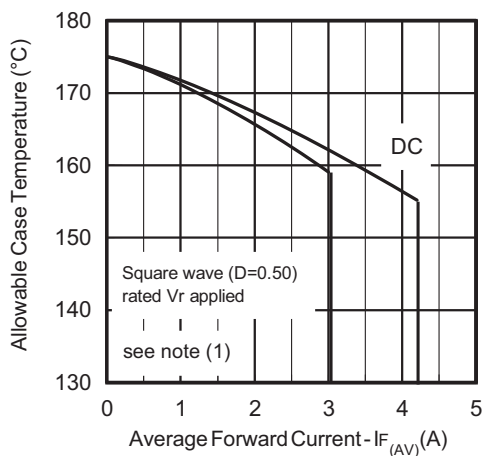


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

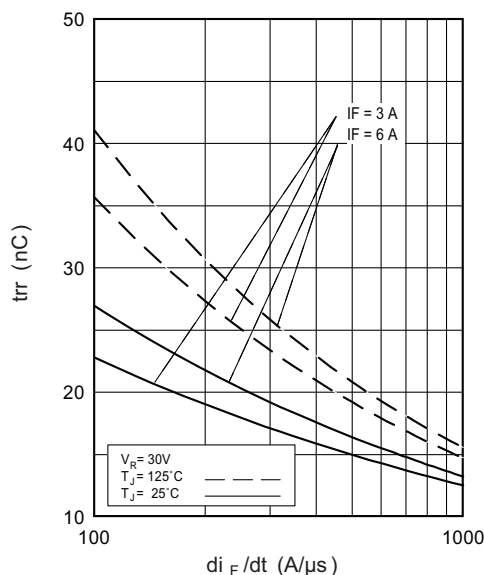


Fig. 7 - Typical Reverse Recovery vs.  $dI_F/dt$

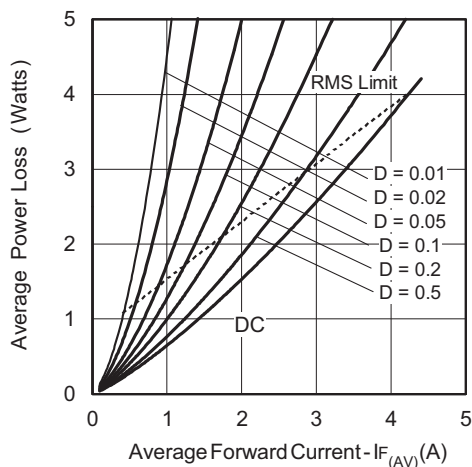


Fig. 6 - Forward Power Loss Characteristics

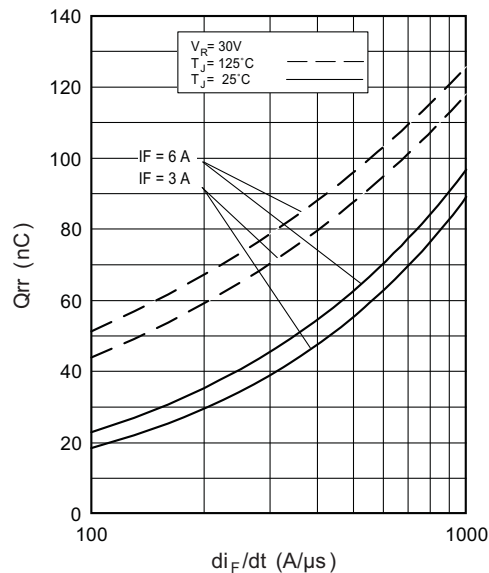


Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  
 $P_{dREV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$

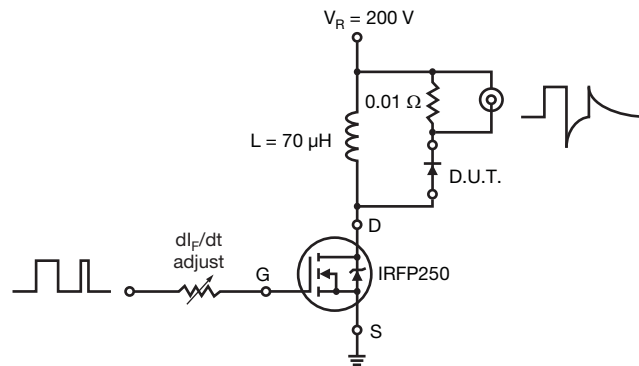


Fig. 9 - Reverse Recovery Parameter Test Circuit

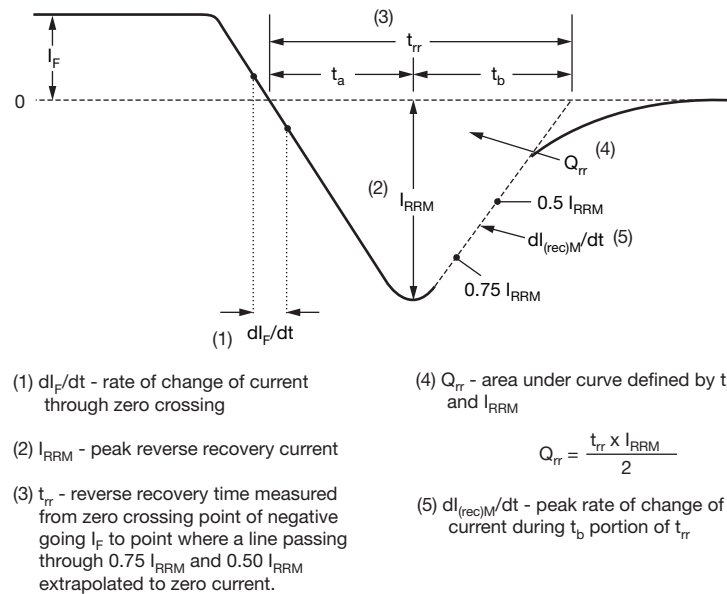


Fig. 10 - Reverse Recovery Waveform and Definitions

**ORDERING INFORMATION TABLE**

Device code	VS-	6	C	W	H	02	FN	TRL	H	M3
	1	2	3	4	5	6	7	8	9	10

- |           |   |   |
|-----------|---|---|
| <b>1</b>  | - | Vishay Semiconductors product   |
| <b>2</b>  | - | Current rating (6 = 6 A)  |
| <b>3</b>  | - | Center tap configuration  |
| <b>4</b>  | - | Package identifier:<br>W = D-PAK  |
| <b>5</b>  | - | H = hyperfast recovery  |
| <b>6</b>  | - | Voltage rating (02 = 200 V)   |
| <b>7</b>  | - | FN = TO-252AA   |
| <b>8</b>  | - | <ul style="list-style-type: none"><li>• None = tube (50 pieces)</li><li>• TR = tape and reel</li><li>• TRL = tape and reel (left oriented)</li><li>• TRR = tape and reel (right oriented)</li></ul> |
| <b>9</b>  | - | H = AEC-Q101 qualified  |
| <b>10</b> | - | Environmental digit:<br>M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free  |

<b>ORDERING INFORMATION</b> (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-6CWH02FNHM3	75	3000	Antistatic plastic tube
VS-6CWH02FNTRHM3	2000	2000	13" diameter reel
VS-6CWH02FNTRRHM3	3000	3000	13" diameter reel
VS-6CWH02FNTRLHM3	3000	3000	13" diameter reel

<b>LINKS TO RELATED DOCUMENTS</b>	
Dimensions	<a href="http://www.vishay.com/doc?95519">www.vishay.com/doc?95519</a>
Part marking information	<a href="http://www.vishay.com/doc?95518">www.vishay.com/doc?95518</a>
Packaging information	<a href="http://www.vishay.com/doc?95033">www.vishay.com/doc?95033</a>



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